<u>MOSFET</u> – N-Channel, SUPERFET[®] II, FRFET[®]

650 V, 76 A, 41 m Ω

FCH041N65EF

Description

SUPERFET II MOSFET is ON Semiconductor's brand-new high voltage super-junction (SJ) MOSFET family that is utilizing charge balance technology for outstanding low on-resistance and lower gate charge performance. This technology is tailored to minimize conduction loss, provide superior switching performance, dv/dt rate and higher avalanche energy. Consequently, SUPERFET II MOSFET is very suitable for the switching power applications such as PFC, server/telecom power, FPD TV power, ATX power and industrial power applications. SUPERFET II FRFET MOSFET's optimized body diode reverse recovery performance can remove additional component and improve system reliability.

Features

- 700 V @ $T_J = 150^{\circ}C$
- Typ. R_{DS(on)} = 36 mΩ
- Ultra Low Gate Charge (Typ. Q_g = 229 nC)
- Low Effective Output Capacitance (Typ. C_{oss(eff.)} = 631 pF)
- 100% Avalanche Tested
- These Device is Pb-Free and is RoHS Compliant

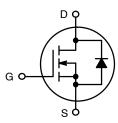
Applications

- LCD / LED / PDP TV
- Telecom / Server Power Supplies
- Solar Inverter
- AC-DC Power Supply



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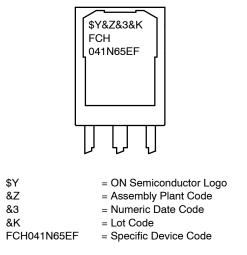






TO-247 long leads CASE 340CH

MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

Symbol	Parameter	Value	Unit V	
V _{DSS}	Drain to Source Voltage	650		
V _{GSS}	Gate to Source Voltage	DC	±20	V
		AC (f > 1 Hz)	±30	
ID	Drain Current	Continuous (T _C = 25°C)	76	А
		Continuous (T _C = 100°C)	48.1	-
I _{DM}	Drain Current	Pulsed (Note 1)	228	А
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		2025	mJ
I _{AR}	Avalanche Current (Note 1)		15	А
E _{AR}	Repetitive Avalanche Energy (Note 1)		5.95	mJ
dv/dt	MOSFET dv/dt		100	V/ns
	Peak Diode Recovery dv/dt (Note 3)		50	
PD	Power Dissipation	(T _C = 25°C)	595	W
		Derate Above 25°C	4.76	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds		300	°C

ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, Unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: pulse width limited by maximum junction temperature. 2. $I_{AS} = 15 \text{ A}, \text{ R}_{G} = 25 \Omega$, starting $T_{J} = 25^{\circ}\text{C}$. 3. $I_{SD} \le 38 \text{ A}, \text{ di/dt} \le 200 \text{ A/}\mu\text{s}, \text{ V}_{DD} \le 380 \text{ V}$, starting $T_{J} = 25^{\circ}\text{C}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	0.21	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max.	40	

PACKAGE MARKING AND ORDERING INFORMATION

	Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FC	CH041N65EF-F155	FCH041N65EF	TO-247	Tube	N/A	N/A	30 Units

ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARACT	ERISTICS					
BV _{DSS}	Drain to Source Breakdown Voltage	V_{GS} = 0 V, I_D = 10 mA, T_J = 25 $^{\circ}C$	650			V
		V_{GS} = 0 V, I _D = 10 mA, T _J = 150°C	700			V
$\Delta \text{BV}_{\text{DSS}} / \Delta \text{T}_{\text{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 10 mA, Referenced to 25°C		0.72		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			10	μA
		V_{DS} = 520 V, T_{C} = 125°C		145		
I _{GSS}	Gate to Body Leakage Current	V_{GS} = ± 20 V, V_{DS} = 0 V			±100	nA
ON CHARACTE	RISTICS					
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 7.6 \text{ mA}$	3		5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 38 A		36	41	mΩ
9 _{FS}	Forward Transconductance	V _{DS} = 20 V, I _D = 38 A		71.7		S
OYNAMIC CHA	RACTERISTICS	•				
C _{iss}	Input Capacitance	V _{DS} = 100 V, V _{GS} = 0 V, f = 1 MHz		9446	12560	pF
C _{oss}	Output Capacitance			366	490	pF
C _{rss}	Reverse Transfer Capacitance			35		pF
C _{oss}	Output Capacitance	V _{DS} = 380 V, V _{GS} = 0 V, f = 1MHz		197		pF
C _{oss(eff.)}	Effective Output Capacitance	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		631		pF
Q _{g(tot)}	Total Gate Charge at 10 V	V_{DS} = 380 V, I _D = 38 A, V _{GS} = 10 V		229	298	nC
Q _{gs}	Gate to Source Gate Charge	(Note 4)	-	50		nC
Q _{gd}	Gate to Drain "Miller" Charge		-	90		nC
ESR	Equivalent Series Resistance	f = 1 MHz		0.6		Ω
WITCHING CH	IARACTERISTICS	•		•		
t _{d(on)}	Turn-On Delay Time	V_{DD} = 380 V, I_{D} = 38 A, V_{GS} = 10 V		55	120	ns
t _r	Turn-On Rise Time	$R_g = 4.7 \Omega$ (Note 4)		65	140	ns
t _{d(off)}	Turn-Off Delay Time			175	360	ns
t _f	Turn-Off Fall Time			48	106	ns
RAIN-SOURC	E DIODE CHARACTERISTICS	•		1		
۱ _S	Maximum Continuous Drain to Source Diode Forward Current				76	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current				228	А
V _{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0 V, I_{SD} = 38A$	1		1.2	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_{SD} = 38 A,$	1	207		ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/µs		1.5		μC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Essentially independent of operating temperature typical characteristics.

TYPICAL PERFORMANCE CHARACTERISTICS

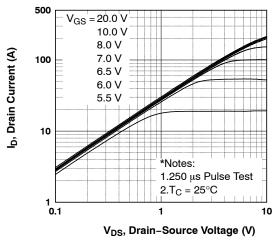


Figure 1. On–Region Characteristics

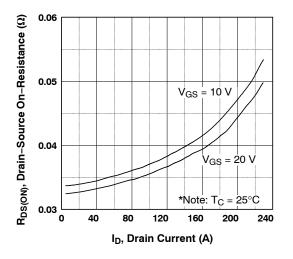
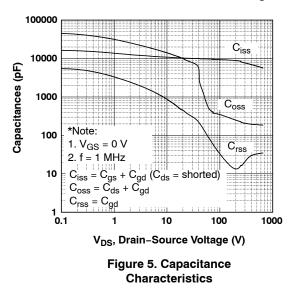
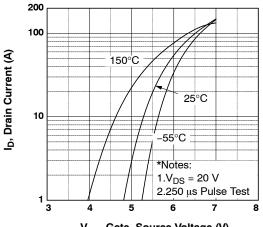


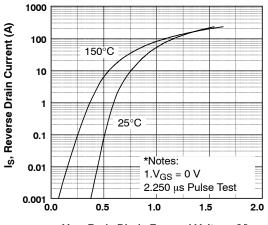
Figure 3. On–Resistance Variation vs. Drain Current and Gate Voltage





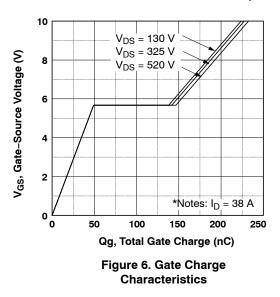
V_{GS}, Gate-Source Voltage (V)

Figure 2. Transfer Characteristics

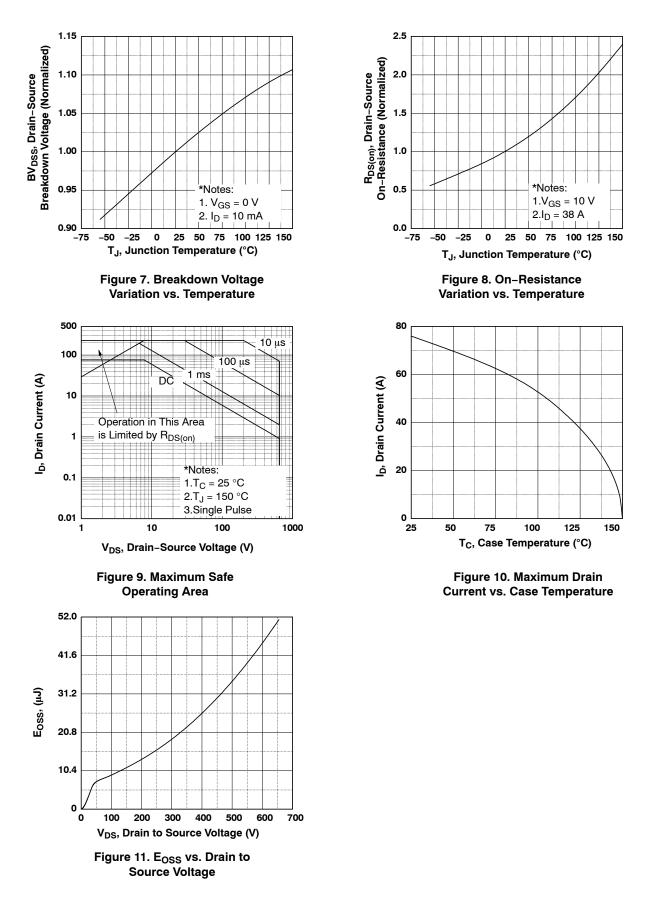


V_{SD}, Body Diode Forward Voltage (V)

Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

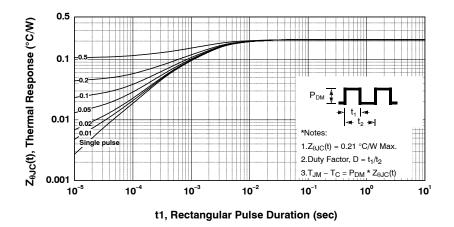


Figure 12. Transient Thermal Response Curve

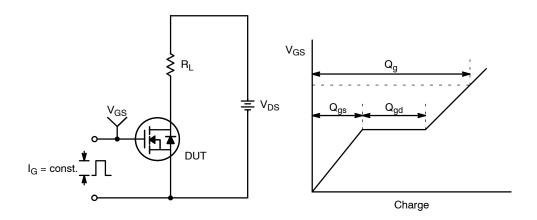


Figure 13. Gate Charge Test Circuit & Waveform

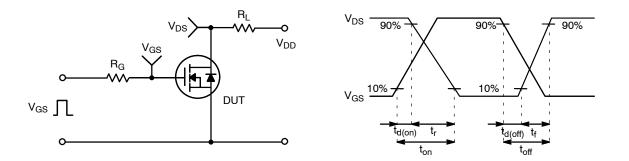


Figure 14. Resistive Switching Test Circuit & Waveforms

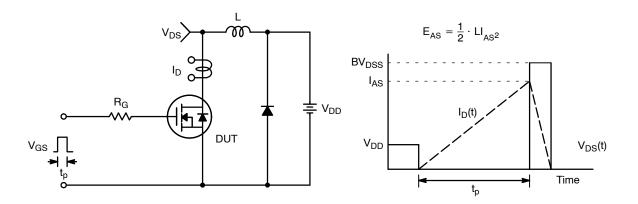


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

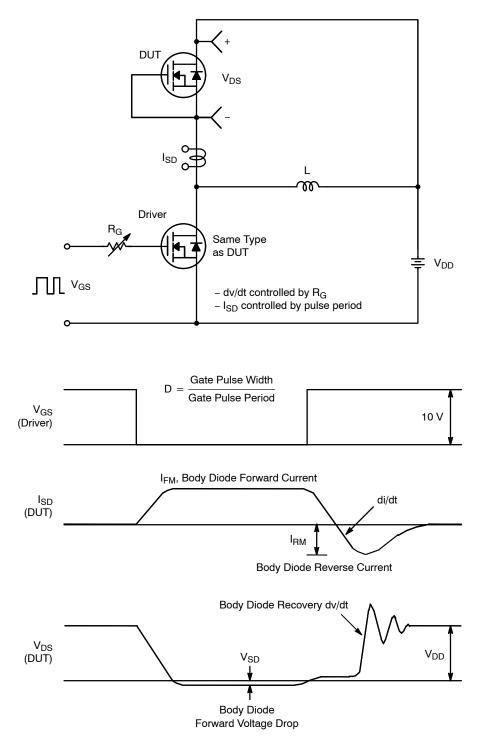
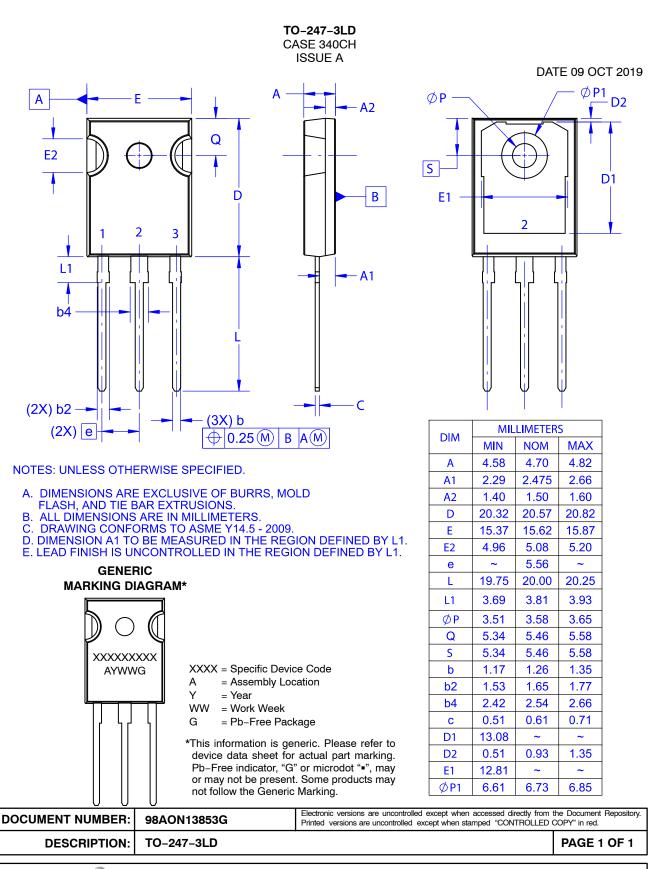


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

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